

**IN THE SPECIFICATION:**

Page 3, lines 31-33:

This galenical form and the process for its manufacture have been described in ~~international~~ published US patent application ~~WO-01/62256~~ 2003/0045522, which is incorporated here by ~~way of~~ reference.

Page 4, lines 17-19:

Within the framework of the present invention, any galenical form as described in said ~~international~~ published US patent application ~~WO-01/62256~~ 2003/0045522 can advantageously be used.